PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Outline

Datasheet

Parameter	Value
V _{CEO}	-50V
Ι _C	-100mA
R ₁	10kΩ

Features

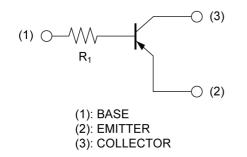
- 1) Built-In Biasing Resistor
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC114T series

Application

INVERTER, INTERFACE, DRIVER

Inner circuit

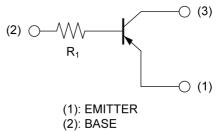
DTA114TM/ DTA114TEB/ DTA114TUB



Packaging specifications

SOT-723	SOT-416FL (1) (2) (3)
DTA114TM	DTA114TEB
(VMT3)	(EMT3F)
SOT-416	SOT-323FL (1) (2) (3)
DTA114TE	DTA114TUB
(EMT3)	(UMT3F)
SOT-323	SOT-346
DTA114TUA	DTA114TKA
(UMT3)	(SMT3)

DTA114TE/ DTA114TUA/ DTA114TKA



(3): COLLECTOR

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA114TM	SOT-723	1212	T2L	180	8	8000	94
DTA114TEB	SOT-416FL	1616	TL	180	8	3000	94
DTA114TE	SOT-416	1616	TL	180	8	3000	94
DTA114TUB	SOT-323FL	2021	TL	180	8	3000	94
DTA114TUA	SOT-323	2021	T106	180	8	3000	94
DTA114TKA	SOT-346	2928	T146	180	8	3000	94

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Pa	arameter	Symbol	Values	Unit
Collector-base voltage			-50	V
Collector-emitter voltage		V _{CEO}	-50	V
Emitter-base voltage		V _{EBO}	-5	V
Collector current			-100	mA
	DTA114TM		150	
	DTA114TEB		150	
Dower dissinction	DTA114TE		150	
Power dissipation	DTA114TUB	Γ _D .	200	— mW
	DTA114TUA		200	
DTA114TKA			200	
Junction temperature	Tj	150	°C	
Range of storage temperation	ture	T _{stg}	-55 to +150	°C

•Electrical characteristics (T_a = 25°C)

Devenuetor	C: reals a l	Candiliana	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	Ι _C = -50μΑ	-50	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-50	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = -50μΑ	-5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -50V	-	-	-500	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -4V	-	-	-500	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -10mA, I _B = -1mA	-	-	-300	mV
DC current gain	h _{FE}	V _{CE} = -5V, I _C = -1mA	100	250	600	-
Input resistance	R ₁	-	7	10	13	kΩ
Transition frequency	f _T *2	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

*1 Each terminal mounted on a reference land.

*2 Characteristics of built-in transistor

-10

-1

-0.1

-0.01

-0.001

0

V_{CE}=-5\

Pulsed

I_B=-500μA

-450µA

-400µA

-350µA -300µA

-250µA

-200µA

-150µA

-100µA

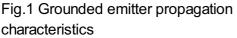
-50µA

-8

0A

-10

● Electrical characteristic curves(Ta=25°C)



COLLECTOR CURRENT : I_c [mA]

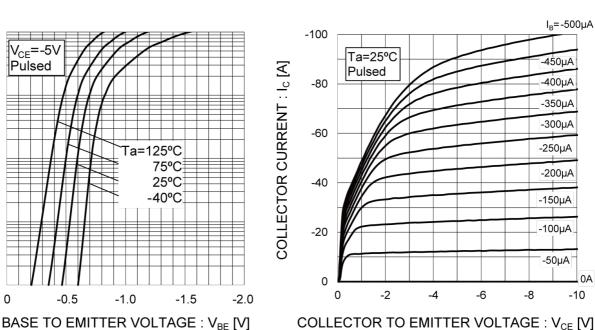
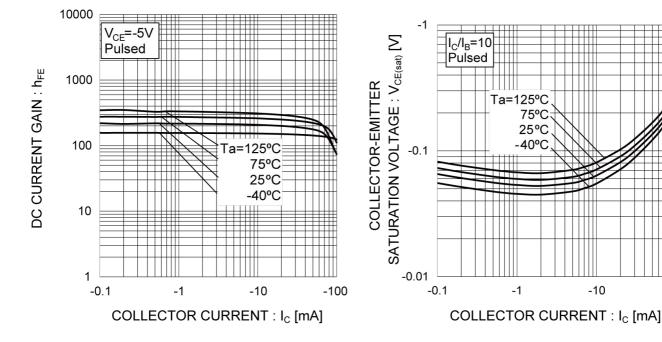


Fig.2 Typical Output Characteristics

Fig.3 DC Current Gain vs. Collector Current

-0.5

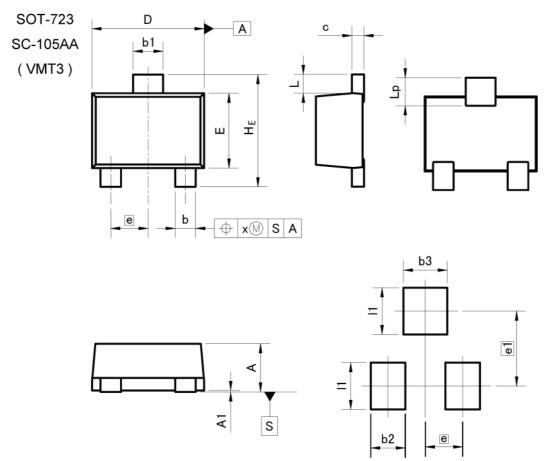
Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current





-100

Dimensions

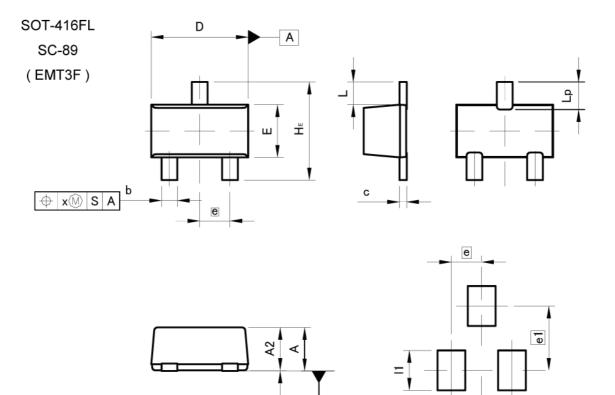


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	-	0.004
			4.1 4.1	
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
b3	_	0.47	—	0.019
e1	0.80		0.031	
1		0.50		0.020



Dimensions



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Pattern of terminal position areas [Not a pattern of soldering pads]

b2

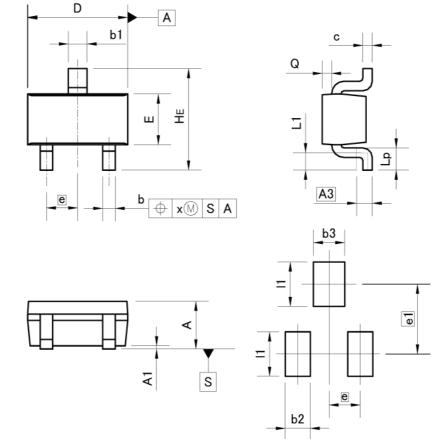
DIM	MILIM	MILIMETERS		HES	
DIM	MIN	MAX	MIN	MAX	
A	0.65	0.85	0.026	0.033	
A1	0.00	0.10	0.000	0.004	
A2	0.60	0.80	0.024	0.031	
b	0.21	0.36	0.008	0.014	
с	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	0.76	0.96	0.030	0.038	
е	0.	50	0.0	20	
HE	1.50	1.70	0.059	0.067	
L	0.	37	0.015		
Lp	0.35	0.55	0.014	0.022	
x	-	0.10	-	0.004	
DIM	MILIM	ETERS	INC	HES	
	MIN	MAX	MIN	MAX	
b2	-	0.46	-	0.018	
e1	-	1.05	-	0.041	
1	-	0.65	-	0.026	



Dimensions



(EMT3)



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15	-	0.006	-
Q	0.05	0.25	0.002	0.010
x	-	0.10		0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	—	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	43
1	0. 	0.70	-	0.028



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

27.997	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
А	0.85	1.05	0.033	0.041	
A1	0.00	0.10	0.000	0.004	
A2	0.80	1.00	0.031	0.039	
b	0.27	0.42	0.011	0.017	
С	0.08	0.18	0.003	0.007	
D	1.90	2.10	0.075	0.083	
Е	1.15	1.35	0.045	0.053	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L	0.4	25	0.017		
Lp	0.43	0.63	0.017	0.025	
x	-	0.10	-	0.004	
DIM	MILIM	ETERS	INC	HES	
DIM	MIN	ΜΔΧ	MIN	ΜΔΧ	

DIM	MILIMETERS		INCHES	
DIN	MIN	MAX	MIN	MAX
b2	-	0.52	-	0.020
e1	1.47		0.0	58
1	- 0.83		-	0.033



Dimensions

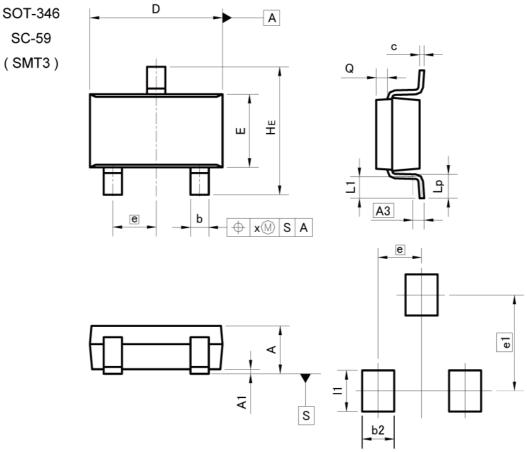


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.50	-	0.020
e1	1.55		0.061	
1	-	0.65	-	0.026



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
с	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIMETERS		INCHES	

DIM	MILIMETERS		INCHES	
DIN	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.083	
1	-	0.90	-	0.035



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CLASSⅢ	CLASSⅢ	CLASS II b	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSII

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 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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